CMD75N06/CMU75N06



N-Channel Enhancement Mode Field Effect Transistor

General Description

The 75N06 uses advanced trench technology and design to provide excellent RDS(ON) with low gate charge. It can be used in a wide variety of applications

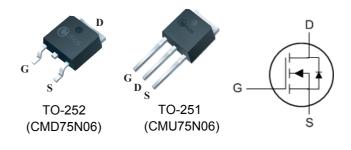
Product Summary

BVDSS	RDSON	ID
60V	12mΩ	75A

Applications

- Power switching application
- Uninterruptible Power Supply
- Hard Switched and High Frequency Circuits

TO-252/251 Pin Configuration



Features

- Low On-Resistance
- 100% avalanche rated
- RoHS Compliant

Absolute Maximum Ratings

Symbol	Parameter	Value	Units	
V _{DS}	Drain-Source Voltage	60	V	
V _{GS}	Gate-Source Voltage	±20	V	
I _D @T _C =25℃	Continuous Drain Current	75	А	
I _D @T _C =100℃	Continuous Drain Current	50	А	
I _{DM}	Pulsed Drain Current ¹ 230		А	
EAS	Single Pulse Avalanche Energy ² 250		mJ	
P₀@T₀=25℃	Total Power Dissipation	110	W	
T _{STG}	Storage Temperature Range -55 to 175		°C	
TJ	Operating Junction Temperature Range -55 to 175		°C	

Thermal Data

Symbol	Parameter Value		Unit	
R _{eJC}	Thermal Resistance Junction-case ²	1.36	°C/W	



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Electrical Characteristics (T_J=25 $^\circ\!\!\mathbb{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	V_{GS} =0V , I _D =250uA	60			V
Passan	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =20A			12	mΩ
R _{DS(ON)}		V _{GS} =4.5V, I _D =10A			16	11122
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS} , I_D =250uA	1		2.5	V
I _{DSS}	Drain-Source Leakage Current	V_{DS} =48V , V_{GS} =0V			1	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} = ±20V , V _{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =10V , I _D =20A		25		S
R _g	Gate Resistance	Vds=0V , Vgs=0V , f=1MHz		6		Ω
Qg	Total Gate Charge	I _D =30A		50		
Q _{gs}	Gate-Source Charge	V _{DS} =30V		12		nC
Q_gd	Gate-Drain Charge	V _{GS} =10V		15		
T _{d(on)}	Turn-On Delay Time	V_{DD} =30V, R _L =15 Ω		16		
Tr	Rise Time	R _G =2.5Ω, I _D =2A		10		20
T _{d(off)}	Turn-Off Delay Time	V _{GS} =10V		45		ns
T _f	Fall Time			12		
C _{iss}	Input Capacitance			3800		
Coss	Output Capacitance	V _{DS} =25V , V _{GS} =0V , f=1MHz		235		pF
C _{rss}	Reverse Transfer Capacitance			200		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	$-V_G=V_D=0V$, Force Current			75	А
I _{SM}	Pulsed Source Current				230	А
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =20 A, TJ=25℃			1.2	V

Note :

1.Pulse width limited by safe operating area.

2.Starting TJ=25 $^\circ\!\!\mathbb{C}$, ID=32 A, VDD= 20V, L=0.5mH.

3.Surface mounted on 1 in $^2\,$ copper pad of FR4 board.

This product has been designed and qualified for the counsumer market.

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